

United States Patent and Trademark Office



UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

DATE MAILED: 07/15/2004

PPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION N
09/516,581	03/01/2000		Eugene A DeLaRosa	M4065.0215/P215	3124
24998	7590	07/15/2004		EXAMINER	
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP 2101 L STREET NW				WERNER, BRIAN P	
WASHINGTON, DC 20037-1526				ART UNIT	PAPER NUMBER
	ŕ			2621	20

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	09/516,581	DELAROSA ET AL.	
Office Action Summary	Examiner	Art Unit	
·	Brian P. Werner	2621	
The MAILING DATE of this communi	ication appears on the cover sheet	vith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR THE MAILING DATE OF THIS COMMUNI - Extensions of time may be available under the provisions after SIX (6) MONTHS from the mailing date of this community of the period for reply specified above is less than thirty (30). If NO period for reply is specified above, the maximum state Failure to reply within the set or extended period for reply Any reply received by the Office later than three months a earned patent term adjustment. See 37 CFR 1.704(b).	CATION. of 37 CFR 1.136(a). In no event, however, may sunication. 0) days, a reply within the statutory minimum of the atutory period will apply and will expire SIX (6) MG will, by statute, cause the application to become	a reply be timely filed airty (30) days will be considered timely. DNTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).	
Status			
1)⊠ Responsive to communication(s) file	d on 20 April 2004		
· · · · · · · · · · · · · · · · · · ·	2b)⊠ This action is non-final.		
3) Since this application is in condition closed in accordance with the practic	for allowance except for formal ma	•	
Disposition of Claims			
4) ⊠ Claim(s) <u>1-39</u> is/are pending in the a 4a) Of the above claim(s) is/ar 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) <u>1-39</u> is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restrice	re withdrawn from consideration.		
Application Papers			
9) The specification is objected to by the 10) The drawing(s) filed on is/are: Applicant may not request that any object Replacement drawing sheet(s) including 11) The oath or declaration is objected to	a) accepted or b) objected to ction to the drawing(s) be held in abeyone the correction is required if the drawing	ance. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim a a) All b) Some * c) None of: 1. Certified copies of the priority 2. Certified copies of the priority 3. Copies of the certified copies	documents have been received. documents have been received in of the priority documents have bee nal Bureau (PCT Rule 17.2(a)).	Application No n received in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (P3) Information Disclosure Statement(s) (PTO-1449 or Paper No(s)/Mail Date	TO-948) Paper No	Summary (PTO-413) o(s)/Mail Date Informal Patent Application (PTO-152) 	

Art Unit: 2621

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on March 29, 2004 (i.e., Amendment B, Paper No. 9) has been entered. Claims 1-39 remain pending.

Information Disclosure Statement

2. Applicant is reminded of his duty to disclose material information known to the applicant that is "material to patentability" (Rule 56). For example, figures 1 and 2 of the Into (US 4,938,600 A) reference cited and applied below are almost identical to the applicant's figures 1 and 2; and the disclosures are almost the same. It is clear from the rejection below that the Into reference is extremely relevant to the prosecution. Into is a good example of a "material" reference. Thus, disclosure of any and all such material known to the applicant is requested.

Art Unit: 2621

Response to Arguments

3. Applicant's arguments with respect to claims 1-39 have been considered but are moot in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 5. Claims 1-9, 11-22, 24-35 and 37-39 are rejected under 35 U.S.C. 102(b) as being anticipated by Into (US 4,938,600 A).

Regarding claim 1, which is representative of claim 27, Into discloses a method for measuring the registration between two integrated circuit layers, one residing over the other ("methods and apparatus for measuring the registration between overlying layers of a semiconductor wafer" at column 1, line 10), comprising:

generating a top-down image of a field of view of the two integrated circuit layers (figures 1 and 2, numeral 22; "camera 22 have a vertical optical axis" at column 4, line 7), each of the layers having a respective visible feature in the image (figures 3A-4B;

Art Unit: 2621

e.g., figure 4A, numeral 70 is a visible feature on a first layer, and numeral 72 is a visible feature on a second layer; refer to column 6, lines 20-23);

digitizing the image and processing the digitized image ("electrical signals representative of the image are supplied to an image processor 28 and a computer 30" at column 4, line 15; "computer 30 processes the signals from the camera 22" at column 4, line 24; The computer is performing the measurement, and thus the signals must be digitized) to determine a relative location of the visible feature of one layer relative to the feature of the other layer (e.g., figure 4A, numerals 70a and 72a each correspond to the center points of the squares 70 and 72; refer to column 6, line 24; see also "to measure displacement between layers of the semiconductor wafer 16" at column 4, line 26; "by measuring the displacement of patterns 50 and 54, the registration between layers 52 and 56 can be quantified" at column 4, line 44); and

determining if the relative location is within acceptable design limits for the integrated circuit layers ("acceptable tolerances on displacement between layers" at column 1, line 28; "outside tolerable limits" at column 1, line 47).

Regarding claim 14, Into discloses an apparatus corresponding to the apparatus disclosed by the applicant. For example, the only two figures depicting the applicant's apparatus appear as figures 1 and 2, which are almost IDENTICAL to Into's figures 1 and 2. The only difference appears at applicant's figure 2, numeral 146. However, according to the specification, the structure of numeral 146 could comprise "a microscope and a video camera" at applicant's specification page 7, line 19. Thus, the

Art Unit: 2621

disclosed structures being equivalent, Into meets the apparatus and means-plusfunction language of claim 14.

Regarding claims 2-5, 15-18 and 28-31, x and y locations of first and second feature reference points are found (e.g., figure 4A, numerals 70a and 72a), from which delta-x and delta-y displacement is measured (figure 4A, "X1" and "Y1"; "x-axis displacement" and "y-axis displacement" at column 6, lines 26-27; a "displacement" as defined by Into is, for example, a "displacement of the squares [or other features] relative to each other" at column 1, line 40; given the situation of figure 4A, where the location of square centers 70a and 72a are determined, from which a displacement is calculated, is necessarily follows that the displacement is a subtraction of x and y values of the coordinates of the square centers).

Regarding claims 6-8, 19-21, and 32-34, Into discloses comparing the relative location with stored tolerance limits (as described in the claim 1 rejection), including calculating an offset value (figure 4A, "X1" and "Y1"; "x-axis displacement" and "y-axis displacement" at column 6, lines 26-27; a "displacement" as defined by Into is, for example, a "displacement of the squares [or other features] relative to each other" at column 1, line 40; given the situation of figure 4A, where the location of square centers 70a and 72a are determined, from which a displacement is calculated, is necessarily follows that the displacement is an offset of one square from the other) and comparing the offset to a predetermined tolerance ("verify registration" and "if the displacement is outside tolerable limits" at column 1, lines 45-48).

Art Unit: 2621

Regarding claims 9, 11, 12, 22, 24, 25, 35, 37 and 38, an imaging system is disclosed comprising a video camera and a microscope (figure 2, numerals 20 and 22).

Regarding claims 13, 26 and 39, semiconductor layers are disclosed (layers of a semiconductor wafer" at column 1, line 10).

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claims 10, 23 and 36 are rejected under 35 U.S.C. 103(a) as being unpatentable over the combination of Into (US 4,938,600 A) and Seiler et al. (US 4,766,311 A).

Into does not teach a scanning electronic microscope.

Seiler discloses a system that captures images of wafers, where the image scanner is a scanning electron microscope ("scanning electron microscopes" at column 2, line 60).

It would have been obvious at the time the invention was made to one of ordinary skill in the art to utilize the electron microscope of Seiler as the image pickup device required by Into to capture images that are "highly precise" (Seiler, column 1, line 10).

Art Unit: 2621

Conclusion

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Brian P. Werner whose telephone number is 703-306-3037. The examiner can normally be reached on M-F, 8:00 - 4:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Leo H. Boudreau can be reached on 703-305-4706. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Brian Werner Primary Examiner Art Unit 2621 July 1, 2004

BRIAN WERNER